

**PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION**

**Part Number:** [0739424200](#)  
**Status:** **Active**  
**Overview:** [hdm](#)  
**Description:** 2.00mm (.079") Pitch HDM® Board-to-Board Backplane Header, Vertical, Solder Tail, Open End, 72 Circuits

**Documents:**

[3D Model](#) [RoHS Certificate of Compliance \(PDF\)](#)  
[Drawing \(PDF\)](#)

**Agency Certification**

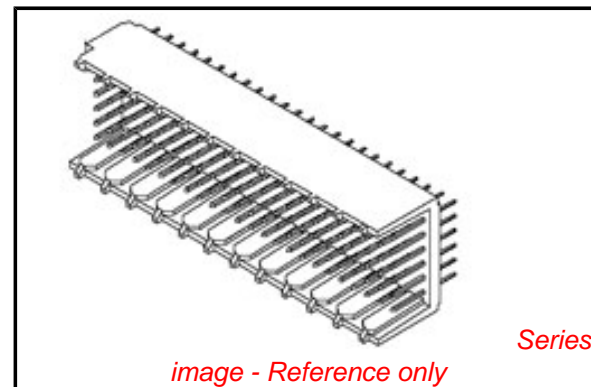
CSA LR19980  
 UL E29179

**General**

Product Family Backplane Connectors  
 Series [73942](#)  
 Application Backplane  
 Comments Solder Tail  
 Component Type PCB Header  
 Overview [hdm](#)  
 Product Name HDM®  
 Style N/A

**Physical**

Circuits (Loaded) 72  
 Circuits (maximum) 72  
 Color - Resin Black, Natural  
 Durability (mating cycles max) 250  
 First Mate / Last Break No  
 Flammability 94V-0  
 Guide to Mating Part No  
 Keying to Mating Part None  
 Material - Metal Phosphor Bronze  
 Material - Plating Mating Gold  
 Material - Plating Termination Tin  
 Material - Resin High Temperature Thermoplastic  
 Number of Columns 12  
 Number of Pairs Open Pin Field  
 Number of Rows 6  
 Orientation Vertical  
 PC Tail Length (in) 0.118 In  
 PC Tail Length (mm) 3.00 mm  
 PCB Retention None  
 PCB Thickness Recommended (in) 0.098 In  
 PCB Thickness Recommended (mm) 2.50 mm  
 Packaging Type Tube  
 Pitch - Mating Interface (in) 0.079 In  
 Pitch - Mating Interface (mm) 2.00 mm  
 Plating min: Mating (µin) 30  
 Plating min: Mating (µm) 0.75  
 Plating min: Termination (µin) 100  
 Plating min: Termination (µm) 2.5  
 Stackable Yes  
 Surface Mount Compatible (SMC) Yes  
 Temperature Range - Operating -55°C to +105°C



**EU RoHS**

**ELV and RoHS  
 Compliant  
 REACH SVHC  
 Not Reviewed  
 Halogen-Free  
 Status  
 Not Reviewed**

**China RoHS**



**Need more information on product  
 environmental compliance?**

Email [productcompliance@molex.com](mailto:productcompliance@molex.com)  
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

**Search Parts in this Series**

[73942Series](#)

**Mates With**

[73632](#) HDM PLUS® Board-to-Board Daughtercard Receptacle. [73780](#) HDM® Board-to-Board Daughtercard Receptacle

**Application Tooling | FAQ**

*Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.*

**Global**

Description	Product #
HDM® Backplane	<a href="#">0621001400</a>
Insertion Signal	
Contact Tool	
Extraction Tool	<a href="#">0621001000</a>

Termination Interface: Style Through Hole

**Electrical**

Current - Maximum per Contact 1A  
Data Rate 1.0 Gbps  
Voltage - Maximum 250V AC

**Material Info**

**Reference - Drawing Numbers**

Packaging Specification PK-70873-0818  
Sales Drawing SD-73942-001

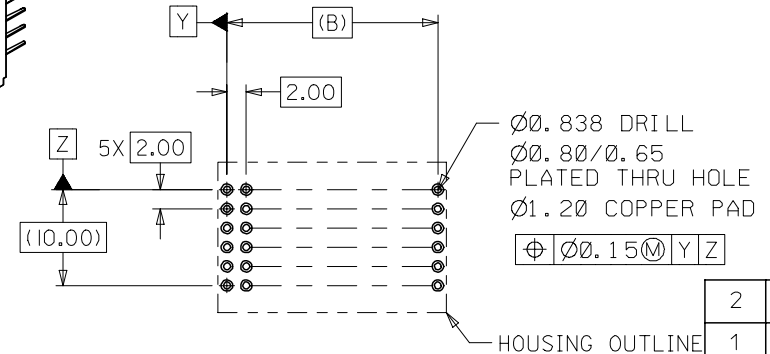
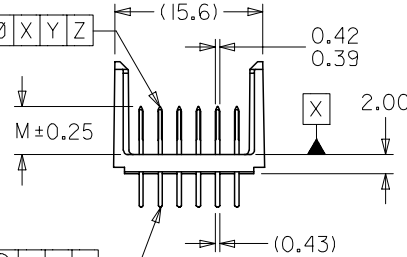
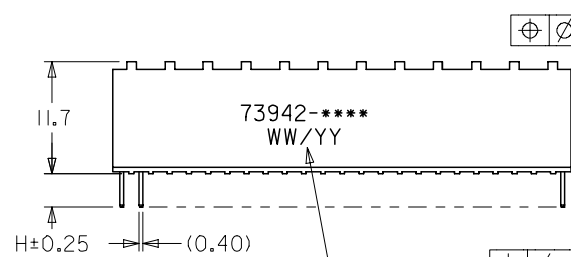
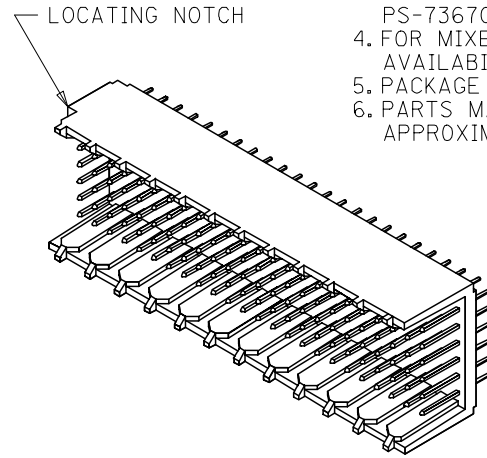
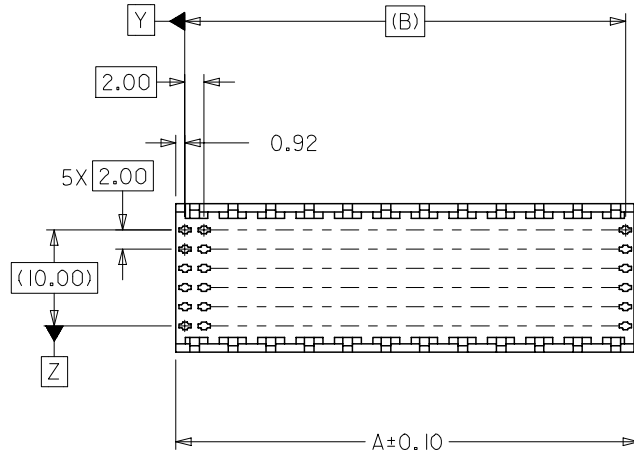
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This document was generated on 05/14/2010

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**NOTES:**

1. MATERIALS: HOUSING--LIQUID CRYSTAL POLYMER (LCP), GLASS FILLED, UL94V-0, COLOR: BLACK, TERMINAL: PHOSPHOR BRONZE.
2. FINISH: 0.75 MICROMETERS MINIMUM SELECTIVE GOLD (Au) IN MATING AREA; 2.50 MICROMETERS MINIMUM SELECTIVE TIN (Sn) IN TAIL AREA; NICKEL (Ni) UNDERPLATE OVERALL.
3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73670-9999.
4. FOR MIXED CONTACT MATING LENGTHS, CONSULT FACTORY FOR AVAILABILITY.
5. PACKAGE PER PK-70873-0818.
6. PARTS MARKED WITH PART NUMBER AND DATE CODE, ON EITHER SIDE, APPROXIMATELY WHERE SHOWN.



PCB LAYOUT: COMPONENT SIDE  
RECOMMENDED PCB THICKNESS: 2.50 MIN.

2	A
1	G
SHT	REV

SEE NOTE 6

MODIFY FINISH NOTE	QUALITY SYMBOLS
EC NO: UCP2007-2259	▽=0
IDRW:MSIBARRA 2007/03/13	▽=0
CHKD:BBARKER 2007/03/21	
APPR:SMILLER 2007/03/22	
DESCRIPTION	
REV	

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.05	± ---
1 PLACE	± 0.10	± ---
ANGULAR ±1/2°		

DIMENSION STYLE  
MM ONLY

DRAWN BY	DATE
JB INGHAM	1998/01/13
CHECKED BY	DATE
SREED	1998/01/13
APPROVED BY	DATE
CBIXLER	1998/01/13
MATERIAL NO.	
SEE CHART	

SCALE  
2:1

TITLE
SALES ASSY HDM BACKPLANE OPEN END OPTION SOLDER TAIL VERSION
MOLEX INCORPORATED
DOCUMENT NO.
SD-73942-001

DESIGN UNITS  
METRIC

THIRD ANGLE PROJECTION
SHEET NO.
1 OF 2

DRAFT WHERE APPLICABLE  
MUST REMAIN  
WITHIN DIMENSIONS




THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

## MATERIAL NUMBER ASSIGNMENT

73942-\* \* 0 0

NUMBER	CIRCUIT SIZE	DIM "A"	DIM "B"	DIM "H"
0	72	23.84	22.00	2.0
1	144	47.84	46.00	2.0
2	72	23.84	22.00	2.5
3	144	47.84	46.00	2.5
4	72	23.84	22.00	3.0
5	144	47.84	46.00	3.0
6	72	23.84	22.00	3.5
7	144	47.84	46.00	3.5

NUMBER	DIM "M"
0	5.0
1	5.5
2	6.0

SEE SHEET 1 EC No. U81577 DRWN:JBINGHAM 98/0203 CHK: SREED 98/0203 APPR:CBIXLER 98/0203	MAJOR  CRITICAL 	QUALITY SYMBOLS	GENERAL TOLERANCES: (UNLESS SPECIFIED)	SCALE ---:--	DESIGN UNITS <input checked="" type="checkbox"/> mm <input type="checkbox"/> INCH	DIMENSIONS: <input type="checkbox"/> mm <input type="checkbox"/> INCH <input checked="" type="checkbox"/> mm ONLY	SHT REV		
		DRAWN BY & DATE JBINGHAM 98/01/13	THIRD ANGLE PROJECTION 		CHECKED BY & DATE SREED 98/01/13		REVISION ON CAD ONLY		
		APPROVED BY & DATE CBIXLER 98/01/13	TITLE: SALES ASSY, HDM BACKPLANE OPEN END OPTION SOLDER TAIL VERSION			MOLEX INCORPORATED			
		ANGLAR: ± °	CAD FILENAME S73942X2.DGN	MATERIAL NO. SEE CHART	DRAWING NO. SD-73942-001	SHEET NO. 2	SIZE B		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.						